

**TOSHIBA****TMP87CM23A/P23**

CMOS 8-Bit Microcontroller

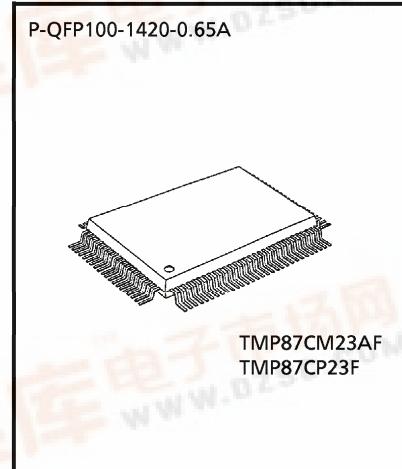
**TMP87CM23AF, TMP87CP23F**

The TMP87CM23A/CP23 are the high speed and high performance 8-bit single chip microcomputers. These MCU contain, large ROM, RAM, input/output ports, LCD driver, a 8-bit AD converter, four multi-function timer/counters, two serial interfaces, and two clock generators on chip.

Product No.	ROM	RAM	Package	OTP MCU
TMP87CM23AF	32 K x 8-bit	1 K x 8-bit	P-QFP100-1420-0.65A	TMP87PP23F
TMP87CP23F	48 K x 8-bit	2 K x 8-bit		

**Features**

- ◆ 8-bit single chip microcomputer TLCS-870 Series
- ◆ Instruction execution time: 0.5  $\mu$ s (at 8 MHz), 122  $\mu$ s (at 32.768 kHz)
- ◆ 129 types and 412 basic instructions
  - Multiplication and Division (8 bits x 8 bits, 16 bits  $\div$  8 bits): Execution time 3.5  $\mu$ s (at 8 MHz)
  - Bit manipulations (Set/Clear/Complement/Load/Store/Test/Exclusive OR)
  - 16-bit data operations
  - 1-byte jump/call (Short relative jump/Vector call)
- ◆ 14 interrupt sources (External: 5, Internal: 9)
  - All sources have independent latches each, and nested interrupt control is available
  - 4 edge-selectable external interrupts with noise reject
  - High-speed task switching by register bank changeover
- ◆ 10 Input/Output ports (Max. 70 pins)
- ◆ Two 16-bit Timer/Counters
  - Timer, Event counter, External trigger timer, Window, PPG output Pulse width measurement modes
- ◆ Two 8-bit Timer/Counters
  - Timer, Event counter, Capture (Pulse width/duty measurement), PWM output, PDO modes
- ◆ Time Base Timer (Interrupt frequency: 1 Hz to 16384 Hz)
- ◆ Divider output function (frequency: 1 kHz to 8 kHz)
- ◆ Watchdog Timer
- ◆ Two 8-bit Serial Interfaces
  - Each 8 bytes transmit/receive data buffer
  - Internal/external serial clock, and 4/8-bit mode



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## ◆LCD driver

- With display memory (20 bytes)
- LCD direct drive capability (Max. 40 seg x 4 com)
- 1/4, 1/3, 1/2 duty or static drive are programmably selectable

## ◆8-bit successive approximate type AD converter with sample and hold

- 8 analog inputs
- Conversion time: 23  $\mu$ s / 92  $\mu$ s (at 8 MHz)

## ◆Dual clock operation (optional)

## ◆Five Power saving operating modes

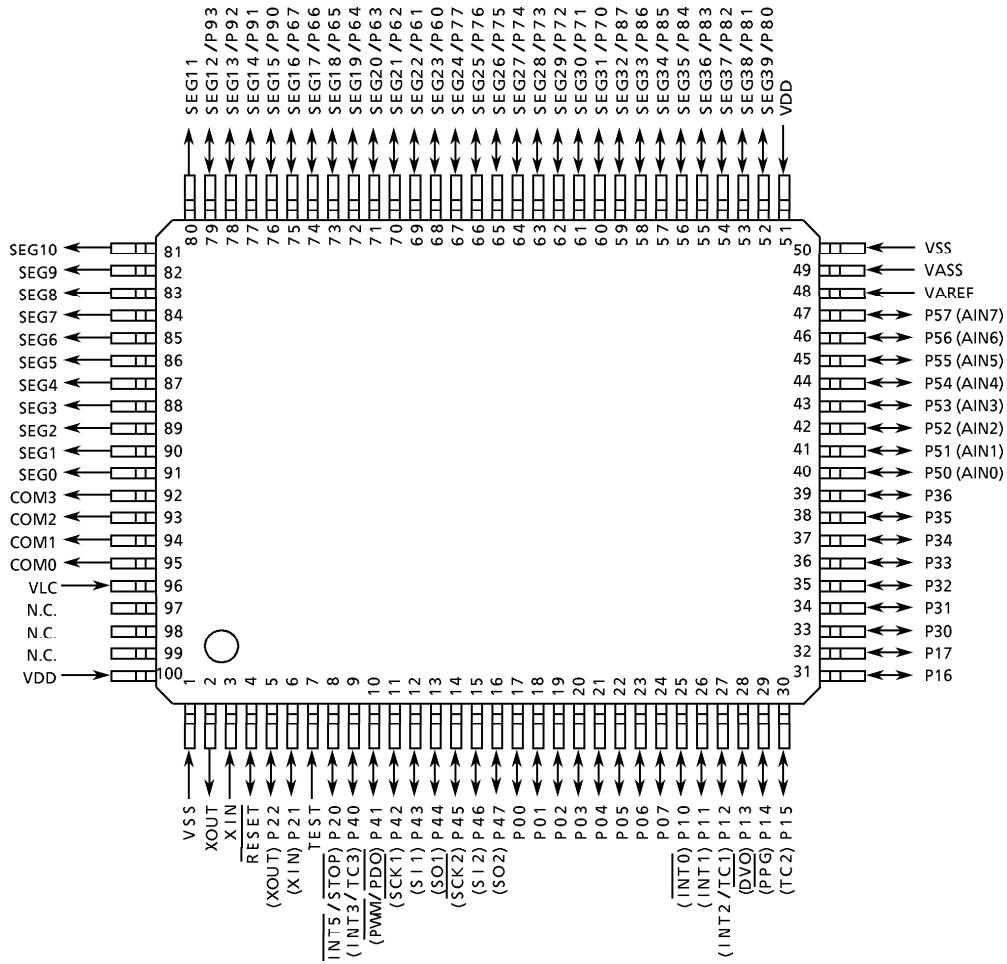
- STOP mode: Oscillation stops. Battery/Capacitor back-up.  
Port output hold/high-impedance.
- SLOW mode: Low power consumption operation using  
low-frequency clock (32.768 kHz).
- IDLE1 mode: CPU stops, and Peripherals operate using  
high-frequency clock.  
Release by interrupts.
- IDLE2 mode: CPU stops, and Peripherals operate using high and low frequency clock.  
Release by interrupts.
- SLEEP mode: CPU stops, and Peripherals operate using low-frequency clock.  
Release by interrupts.

## ◆Operating Voltage: 2.7 to 5.5 V at 4.2 MHz / 32.768 kHz, 4.5 to 5.5 V at 8 MHz / 32.768 kHz

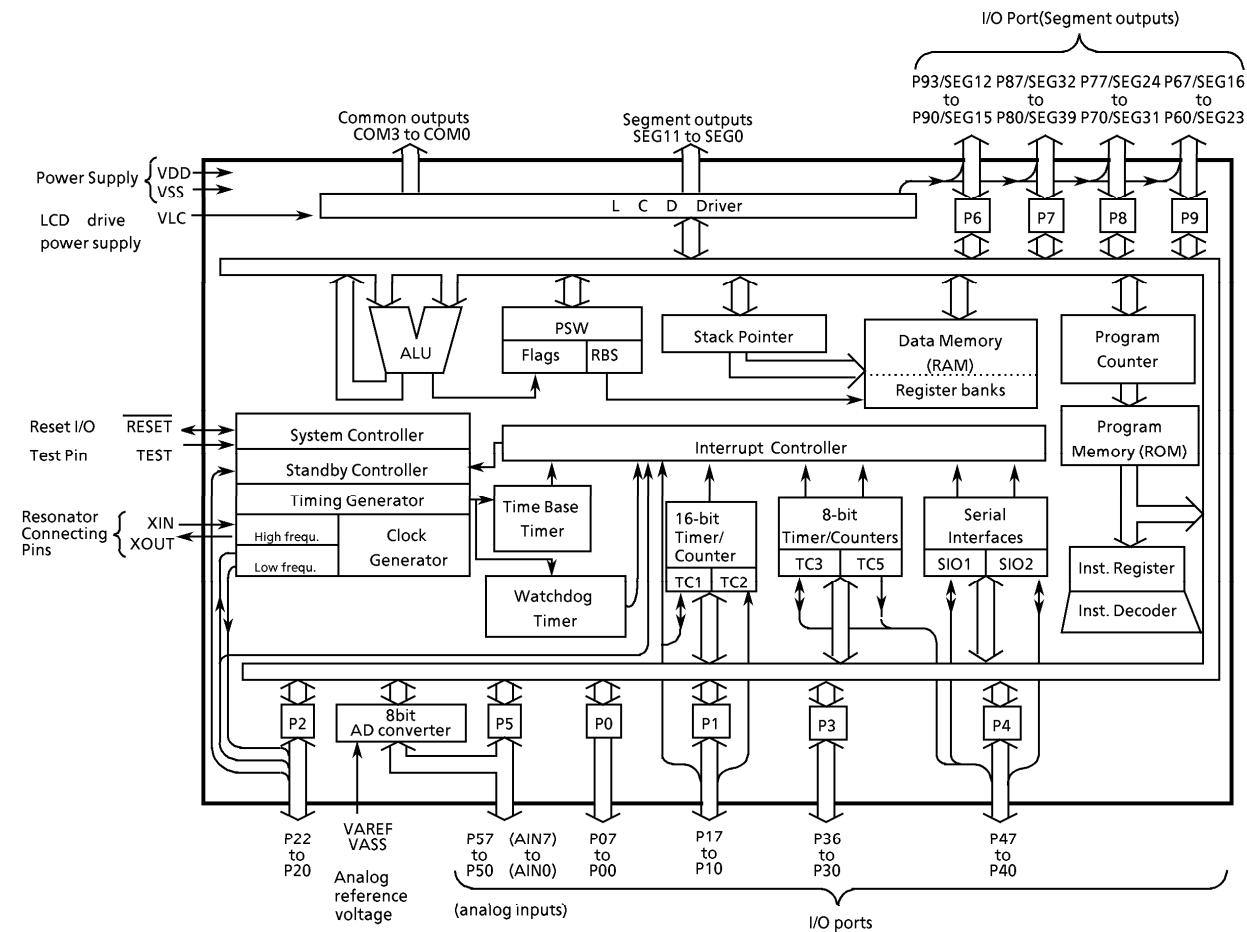
## ◆Emulation Pod: BM87CP23F0A

## Pin Assignments (Top View)

P-QFP100-1420-0.65A



## Block Diagram



## Pin Function

Pin Name	Input / Output	Function
P07 to P00	I/O	8-bit programmable input/output ports (tri-state).
P17, P16		
P15 (TC2)	I/O (Input)	Each bit of these ports can be individually configured as an input or an output under software control.
P14 (PPG)	I/O (Output)	Programmable pulse generator output
P13 (DVO)		Divider output
P12 (INT2 / TC1)		External interrupt 2 input or Timer/Counter 1 input
P11 (INT1)	I/O (Input)	External interrupt 1 input
P10 (INT0)		External interrupt 0 input
P22 (XTOUT)	I/O (Output)	Resonator connecting pins (32.768kHz). For inputting external clock, XTIN is used and XTOUT is opened.
P21 (XTIN)	I/O (Input)	
P20 (INT5 / STOP)		External interrupt 5 input or STOP mode release signal input
P36 to P30	I/O	7-bit input/output port with latch. When used as input port, the output latch must be set to "1".
P47 (SO2)	I/O (Output)	8-bit input/output port with latch.
P46 (S12)	I/O (Input)	SIO2 serial data output
P45 (SCK2)	I/O (I/O)	SIO2 serial data input
P44 (SO1)	I/O (Output)	SIO2 serial clock input/output
P43 (S11)	I/O (Input)	SIO1 serial data output
P42 (SCK1)	I/O (I/O)	SIO1 serial data input
P41 (PWM/PDO)	I/O (Output)	SIO1 serial clock input/output
P40 (INT3 / TC3)	I/O (Input)	8-bit PWM output, 8-bit programmable divider output External interrupt 3 input, Timer/Counter 3 input
P57 (AIN07) to P50 (AIN00)	I/O (Input)	AD converter analog inputs
SEG39 (P80) to SEG32 (P87)	Output (I/O)	8-bit input/output port with latch. When used as an input port, the segment output control register must be set to "0" after setting output latch to "1".
SEG31 (P70) to SEG24 (P77)	Output (I/O)	LCD segment outputs. When used as segment output, the segment output control register must be set to "1".
SEG23 (P60) to SEG16 (P67)	Output (I/O)	
SEG15 (P90) to SEG12 (P93)	Output (I/O)	4-bit input/output port with latch. When used as an input port, the segment output control register must be set to "1" after setting output latch to "1".
SEG11 to SEG0	Output	LCD segment outputs
COM3 to COM0	Output	LCD common outputs
XIN, XOUT	Input, Output	Resonator connecting pins for high-frequency clock. For inputting external clock, XIN is used and XOUT is opened.
RESET	I/O	Reset signal input or watchdog timer output/address-trap-reset output
TEST	Input	Test pin for out-going test. Be fixed to low.
VDD, VSS	Power Supply	+ 5 V, 0 V (GND)
VAREF, VASS		Analog reference voltage inputs (High, Low)
VLC		LCD drive power supply.

## OPERATIONAL DESCRIPTION

### 1. CPU CORE FUNCTIONS

The CPU core consists of a CPU, a system clock controller, an interrupt controller, and a watchdog timer. This section provides a description of the CPU core, the program memory (ROM), the data memory (RAM), and the reset circuit.

#### 1.1 Memory Address Map

The TLCS-870 Series is capable of addressing 64K bytes of memory. Figure 1-1 shows the memory address maps of the TMP87CM23A/P23. In the TLCS-870 Series, the memory is organized 4 address spaces (ROM, RAM, SFR, and DBR). It uses a memory mapped I/O system, and all I/O registers are mapped in the SFR/DBR address spaces. There are 16 banks of general-purpose registers. The register banks are also assigned to the first 128 bytes of the RAM address space.

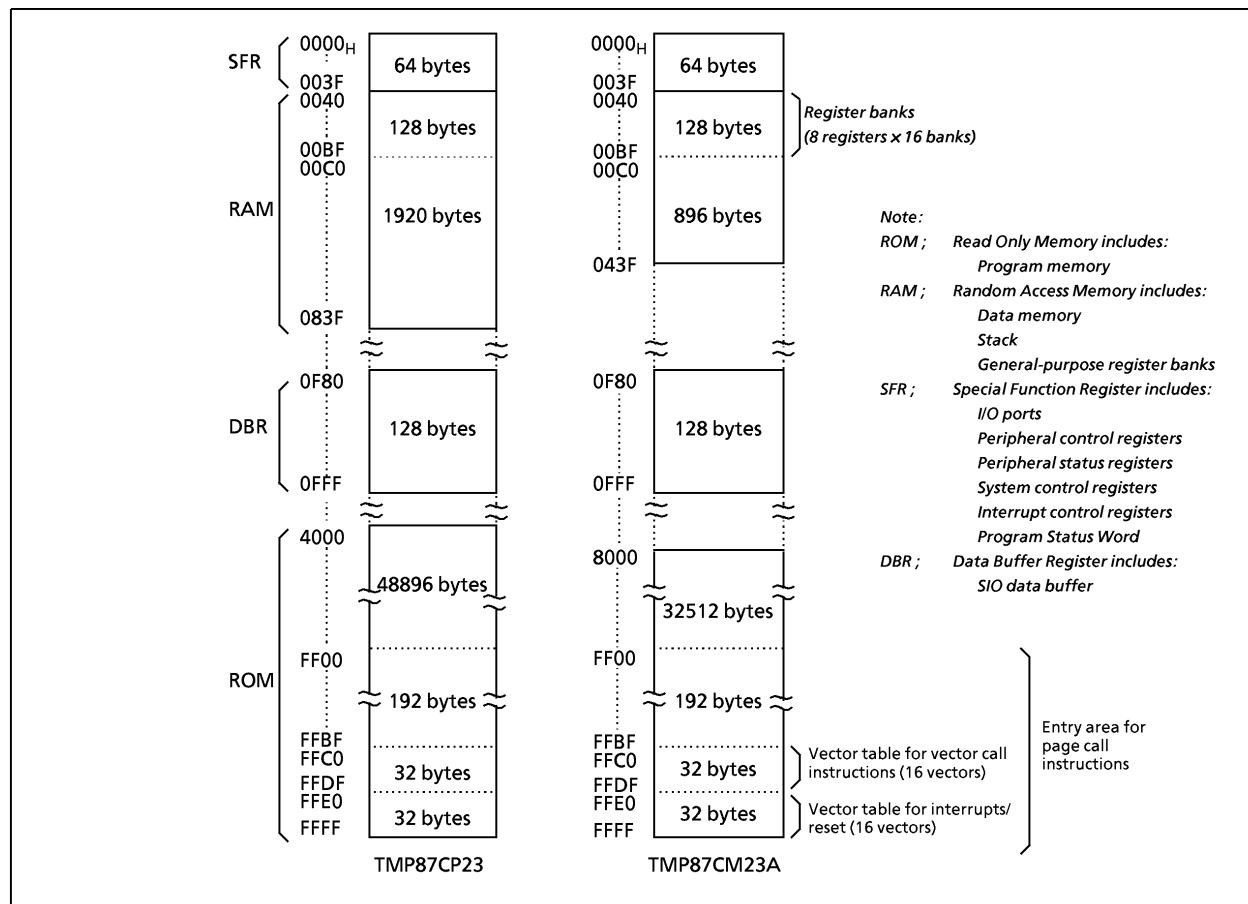


Figure 1-1. Memory Address Maps

## Electrical Characteristics

Absolute Maximum Ratings		(V <sub>SS</sub> = 0 V)		
Parameter	Symbol	Pins	Ratings	Unit
Supply Voltage	V <sub>DD</sub>		- 0.3 to 6.5	V
Input Voltage	V <sub>IN</sub>		- 0.3 to V <sub>DD</sub> + 0.3	V
Output Voltage	V <sub>OUT</sub>		- 0.3 to V <sub>DD</sub> + 0.3	V
Output Current (Per 1 pin)	I <sub>OUT1</sub>	Ports P0, P1, P2, P3, P5, P6, P7, P8, P9, P4 (except P41)	3.2	mA
	I <sub>OUT2</sub>	P41	30	
Output Current (Total)	Σ I <sub>OUT1</sub>	Ports P0, P1, P2, P3, P5, P6, P7, P8, P9, P4 (except P41)	120	mA
	Σ I <sub>OUT2</sub>	P41	30	
Power Dissipation [Topr = 70°C]	PD		350	mW
Soldering Temperature (time)	T <sub>sld</sub>		260 (10 s)	°C
Storage Temperature	T <sub>stg</sub>		- 55 to 125	°C
Operating Temperature	T <sub>opr</sub>		- 30 to 70	°C

**Note 1:** The absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, a device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

**Note 2:** The absolute maximum input/output voltage ratings for the TMP87CM23A/CP23/PP23 are - 0.3 to V<sub>DD</sub> + 0.3 [V] at all I/O ports including sink open drain output ports. (However, the V<sub>PP</sub> pin of TMP87PP23 is not contained in these condition.)

Recommended Operating Conditions		(V <sub>SS</sub> = 0 V, T <sub>opr</sub> = - 30 to 70°C)							
Parameter	Symbol	Pins	Conditions		Min	Max	Unit		
Supply Voltage	V <sub>DD</sub>		fc = 8 MHz	NORMAL1, 2 mode	4.5	5.5	V		
				IDLE1, 2 mode					
			fc = 4.2 MHz	NORMAL1, 2 mode	2.7				
				IDLE1, 2 mode					
			fs = 32.768 kHz	SLOW mode	2.7				
				SLEEP mode					
				STOP mode	2.0				
Input High Voltage	V <sub>IH1</sub>	Except hysteresis input	V <sub>DD</sub> ≥ 4.5 V		V <sub>DD</sub> × 0.70	V <sub>DD</sub>	V		
	V <sub>IH2</sub>	Hysteresis input			V <sub>DD</sub> × 0.75				
	V <sub>IH3</sub>		V <sub>DD</sub> < 4.5 V		V <sub>DD</sub> × 0.90				
Input Low Voltage	V <sub>IL1</sub>	Except hysteresis input	V <sub>DD</sub> ≥ 4.5 V		0	V <sub>DD</sub> × 0.30	V		
	V <sub>IL2</sub>	Hysteresis input							
	V <sub>IL3</sub>		V <sub>DD</sub> < 4.5 V						
Clock Frequency	V <sub>fc</sub>	XIN, XOUT	V <sub>DD</sub> = 4.5 to 5.5 V		0.4	8.0	MHz		
	fs	XTIN, XTOUT							
			V <sub>DD</sub> = 2.7 to 5.5 V		30.0	4.2			

**Note 1:** The recommended operating conditions for a device are operating conditions under which it can be guaranteed that the device will operate as specified. If the device is used under operating conditions other than the recommended operating conditions (supply voltage, operating temperature range, specified AC/DC values etc.), malfunction may occur. Thus, when designing products which include this device, ensure that the recommended operating conditions for the device are always adhered to.

**Note 2:** Clock frequency fc: Supply voltage range is specified in NORMAL1/2 mode and IDLE1/2 mode.

DC Characteristics			$(V_{SS} = 0 \text{ V}, Topr = -30 \text{ to } 70^\circ\text{C})$							
Parameter	Symbol	Pins	Conditions	Min	Typ.	Max	Unit			
Hysteresis Voltage	$V_{HS}$	Hysteresis inputs		—	0.9	—	V			
Input Current	$I_{IN1}$	TEST	$V_{DD} = 5.5 \text{ V}, V_{IN} = 5.5 \text{ V} / 0 \text{ V}$	—	—	$\pm 2$	$\mu\text{A}$			
	$I_{IN2}$	Open drain ports and tri-state ports								
	$I_{IN3}$	RESET, STOP								
Input Low Current	$I_{IL}$	Push-pull ports	$V_{DD} = 5.5 \text{ V}, V_{IN} = 0.4 \text{ V}$	—	—	-2	mA			
Input Resistance	$R_{IN2}$	RESET		100	220	450	k $\Omega$			
Output Leakage Current	$I_{LO1}$	Open drain ports	$V_{DD} = 5.5 \text{ V}, V_{OUT} = 5.5 \text{ V}$	—	—	2	$\mu\text{A}$			
	$I_{LO2}$	Tri-state ports	$V_{OUT} = 5.5 \text{ V} / 0 \text{ V}$	—	—	$\pm 2$				
Segment Output Low Resistance	$R_{OS1}$	SEG39 to SEG0	$V_{DD} = 5 \text{ V}, V_{DD} - V_{LC} = 3 \text{ V}$	—	20	—	$\text{k}\Omega$			
Common Output Low Resistance	$R_{OC1}$	COM3 to COM0								
Segment Output High Resistance	$R_{OS2}$	SEG39 to SEG0								
Common Output High Resistance	$R_{OC2}$	COM3 to COM0								
Segment/Common Output Voltage	$V_{O2/3}$	SEG39 to SEG0 and COM3 to COM0			3.8	4.0	4.2	V		
	$V_{O1/2}$				3.3	3.5	3.7			
	$V_{O1/3}$				2.8	3.0	3.2			
Output High Voltage	$V_{OH1}$	Push-pull ports (P4 port)	$V_{DD} = 4.5 \text{ V}, I_{OH} = -200 \mu\text{A}$	2.4	—	—	V			
	$V_{OH2}$	Tri-state ports (P0, P1, P5 ports)	$V_{DD} = 4.5 \text{ V}, I_{OH} = -0.7 \text{ mA}$	4.1	—	—				
Output Low Voltage	$V_{OL}$	Except XOUT and P41	$V_{DD} = 4.5 \text{ V}, I_{OL} = 1.6 \text{ mA}$	—	—	0.4	V			
Output Low Current	$I_{OL3}$	P41	$V_{DD} = 4.5 \text{ V}, V_{OL} = 1.0 \text{ V}$	—	20	—	mA			
Supply Current in NORMAL 1, 2 mode	$I_{DD}$		$V_{DD} = 5.5 \text{ V}$ $f_c = 8 \text{ MHz}$ $f_s = 32.768 \text{ kHz}$ $V_{IN} = 5.3 \text{ V} / 0.2 \text{ V}$	—	10	16	mA			
Supply Current in IDLE 1, 2 mode			—	6	10					
Supply Current in SLOW mode			$V_{DD} = 3.0 \text{ V}$ $f_s = 32.768 \text{ kHz}$ $V_{IN} = 2.8 \text{ V} / 0.2 \text{ V}$ LCD driver is not enable	—	30	60	$\mu\text{A}$			
Supply Current in SLEEP mode			—	15	30	$\mu\text{A}$				
Supply Current in STOP mode			$V_{DD} = 5.5 \text{ V}$ $V_{IN} = 5.3 \text{ V} / 0.2 \text{ V}$	—	0.5	10	$\mu\text{A}$			

Note 1: Typical values show those at  $Topr = 25^\circ\text{C}$ ,  $V_{DD} = 5 \text{ V}$ .

Note 2: Input Current ; The current through pull-up or pull-down resistor is not included.

Note 3:  $I_{DD}$  ; Except for  $I_{REF}$

Note 4: Output resistors  $R_{OS}$ ,  $R_{OC}$  indicate "on" when switching levels.

Note 5:  $V_{O2/3}$  indicates an output voltage at the 2/3 level when operating in the 1/4 or 1/3 duty mode.

Note 6:  $V_{O1/2}$  indicates an output voltage at the 1/2 level when operating in the 1/2 duty or static mode.

Note 7:  $V_{O1/3}$  indicates an output voltage at the 1/3 level when operating in the 1/4 or 1/3 duty mode.

Note 8: When using LCD, it is necessary to consider values of  $R_{OS1/2}$  and  $R_{OC1/2}$ .

Note 9: Times for SEG/COM output switching on:  $R_{OS1}, R_{OC1}: 26/f_c, 2/f_c (\text{s})$

$R_{OS2}, R_{OC2}: 1/(n, f_F) (\text{1/n: duty, } f_F: \text{frame frequency})$

## AD Conversion Characteristics

(V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 2.7 to 5.5 V, Topr = -30 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit
Analog Reference Voltage	V <sub>AREF</sub>	V <sub>AREF</sub> - V <sub>ASS</sub> ≥ 2.5 V	2.7	-	V <sub>DD</sub>	V
	V <sub>ASS</sub>		V <sub>SS</sub>	-	1.5	
Analog Input Voltage	V <sub>AIN</sub>		V <sub>ASS</sub>	-	V <sub>AREF</sub>	V
Analog Supply Current	I <sub>REF</sub>	V <sub>AREF</sub> = 5.5 V, V <sub>ASS</sub> = 0.0 V	-	0.5	1.0	mA
Nonlinearity Error		V <sub>DD</sub> = 5.0 V, V <sub>SS</sub> = 0.0 V V <sub>AREF</sub> = 5.000 V	-	-	± 1	LSB
Zero Point Error		V <sub>ASS</sub> = 0.000 V or	-	-	± 1	
Full Scale Error		V <sub>DD</sub> = 2.7 V, V <sub>SS</sub> = 0.0 V V <sub>AREF</sub> = 2.700 V	-	-	± 1	
Total Error		V <sub>ASS</sub> = 0.000 V	-	-	± 2	

Note: Quantizing error is not contained in those errors.

## AC Characteristics

(V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 4.5 to 5.5 V, Topr = -30 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit	
Machine Cycle Time	t <sub>cy</sub>	In NORMAL 1, 2 mode	0.95	-	10	μs	
		In IDLE 1, 2 mode					
		In SLOW mode	117.6	-	133.3		
		In SLEEP mode					
High Level Clock Pulse Width	t <sub>WCH</sub>	For external clock operation (XIN input), fc = 8 MHz	50	-	-	ns	
Low Level Clock Pulse Width	t <sub>WCL</sub>						
High Level Clock Pulse Width	t <sub>WSH</sub>	For external clock operation (XTIN input), fs = 32.768 kHz	14.7	-	-	μs	
Low Level Clock Pulse Width	t <sub>WSL</sub>						

(V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 2.7 to 5.5 V, Topr = -30 to 70°C)

Parameter	Symbol	Conditions	Min	Typ.	Max	Unit	
Machine Cycle Time	t <sub>cy</sub>	In NORMAL 1, 2 mode	0.95	-	10	μs	
		In IDLE 1, 2 mode					
		In SLOW mode	117.6	-	133.3		
		In SLEEP mode					
High Level Clock Pulse Width	t <sub>WCH</sub>	For external clock operation (XIN input), fc = 4.2 MHz	110	-	-	ns	
Low Level Clock Pulse Width	t <sub>WCL</sub>						
High Level Clock Pulse Width	t <sub>WSH</sub>	For external clock operation (XTIN input), fs = 32.768 kHz	14.7	-	-	μs	
Low Level Clock Pulse Width	t <sub>WSL</sub>						

## Recomended Oscillating Condition-1 (for TMP87CP23)

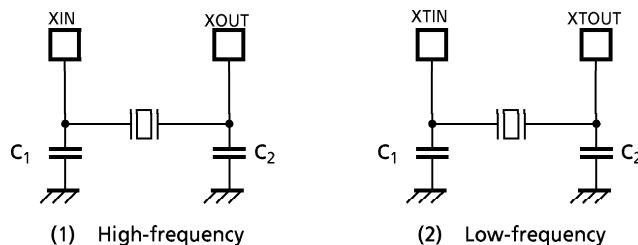
(VSS = 0 V, VDD = 4.5 to 5.5 V, Topr = -30 to 70°C)

Parameter	Osillator	Frequency	Recommender Oscillator	Recommended Condition	
				C <sub>1</sub>	C <sub>2</sub>
High- frequency	Ceramic Resonator	8 MHz	KYOCERA KBR8.0M	30 pF	30 pF
			Standard/Lead Type CSA8.00MTZ (MURATA) CST8.00MTW	Built-in 30 pF	Built-in 30 pF
			Standard/SMP Type CSACS8.00MT (MURATA)	30 pF	30 pF
		4 MHz	Standard/Small Chip Type CSTCS8.00MT (MURATA)	Built-in 30 pF	Built-in 30 pF
	Crystal Oscillator	8 MHz	KYOCERA KBR4.0MS	30 pF	30 pF
		4 MHz	TOYOCOM 210B 8.0000	20 pF	20 pF
Low-frequency	Crystal Oscillator	32.768 kHz	NDK MX-38T		

## Recomended Oscillating Condition-2 (for TMP87CP23)

(VSS = 0V, VDD = 2.7 to 5.5V, Topr = -30 to 70°C)

Parameter	Osillator	Frequency	Recommender Oscillator	Recommended Condition	
				C <sub>1</sub>	C <sub>2</sub>
High- frequency	Ceramic Resonator	4 MHz	Standard/Lead Type CSA4.00MG (MURATA) CST4.00MGW	30 pF	30 pF
			Built-in 30 pF	Built-in 30 pF	
			Standard/SMD Type CSA4.00MGC (MURATA) CSAC4.00MGCM CSTC4.00MG	30 pF	30 pF
			Built-in 30 pF	Built-in 30 pF	
			Standard/Small Chip Type CSTCS4.00MG	Built-in 10 pF	Built-in 10 pF



Note 1: When used in high electric field such as a picture tube, the package is recommended to be electrically shielded to maintain a regular operation.

Note 2: The product numbers and specifications of the resonators by Murata Manufacturing Co., Ltd. are subject to change.  
For up-to-date information, please refer to the following URL;  
<http://www.murata.co.jp/search/index.html>